

TC32M

ECONOMONITORTM – 3-Pin System Supervisor with Power Supply Monitor and Watchdog

Features

- Incorporates the Functionality of the Industry Standard TC1232 (Processor Monitor, Watchdog and Manual Override RESET Controller) into a Small, Lower Cost Package
- Guards Against Unstable Processor Operation Resulting from Power "Brown-Out"
- Automatically Halts and Restarts an Out-of-Control Microprocessor
- Output can be Wire-ORed, or Hooked to Manual RESET Push-button Switch
- Space-Saving 3-Pin TO-92 or SOT-223 Package

Applications

- · All Microprocessor-Based Systems
- Battery Powered Computers and Controllers
- · Automotive Systems
- Intelligent Instruments
- Critical Processor Monitoring
- Embedded Controllers

Device Selection Table

Part Number	Package	Temp. Range		
TC32MCDB	SOT-223	0°C to +70°C		
TC32MCZB	TO-92	0°C to +70°C		
TC32MEDB	SOT-223	-40°C to +85°C		
TC32MEZB	TO-92	-40°C to +85°C		

Package Type



General Description

The TC32M is a fully-integrated processor supervisor in a 3-pin package. It provides three important functions to safeguard processor sanity: precision power on/off RESET control, watchdog timer and external RESET override.

On power-up, the TC32M holds the processor in the reset state for a minimum of 500msec after V_{DD} is within tolerance to ensure a stable system start-up. Microprocessor sanity is monitored by the on-board watchdog circuit. The microprocessor must provide a high-to-low level shift (through an external resistor divider) on the RS pin of the TC32M. Should the processor fail to supply this signal within the specified timeout period (typically 700msec), an out-of-control processor is indicated and the TC32M issues a processor reset as a result.

The output of the TC32M can be wire-ORed with a push-button switch (or electronic signal) to override the TC32M and unconditionally reset the processor. When connected to a push-button switch, the TC32M provides contact debounce.

The TC32M is packaged in a space-saving TO-92 or SOT-223 package. It provides all of the functionality of the industry standard TC1232 in a smaller, lower cost configuration.

Functional Block Diagram



Typical Operating Circuit



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings*

Supply Voltage (V _{DD} to GND)+6.0V					
Input Voltage Any Pin (GND – 0.3V) to (V _{DD} +0.3V)					
Operating Temperature Range					
TC32MC Package0°C to +70°C					
TC32ME Package40°C to +85°C					
Storage Temperature Range65°C to +150°C					

TC32M ELECTRICAL SPECIFICATIONS

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

Recommended DC Operating Conditions: T _A = -40°C to +85°C unless otherwise noted.								
Symbol	Parameter	Min	Тур	Max	Units	Test Conditions		
V _{DD}	Supply Voltage	4.5	_	5.5	V			
V _{IH}	RS Input HIGH Level for PB	2.0		_	V			
V _{IL}	RS Input LOW Level for PB	—	_	0.3	V			
DC Electrical Characteristics: $V_{DD} = 4.5V$ to 5.5V, $T_A = -40^{\circ}C$ to +85°C unless otherwise noted.								
Symbol	Parameter	Min	Тур	Max	Units	Test Conditions		
IIL	RS Input Leakage	-1	_	+1	μA			
l _{ol}	RS Output Current	2.0	10	—	mA	V _{OL} = 0.4V		
I _{CC}	Operating Current	—	50	200	μΑ	Note 1		
V _{STH}	RS Strobe HIGH Level	$(V_{DD} - 0.5V)$	_	—	V	Figure 3-1		
V _{STL}	RS Strobe LOW Level	2.00	_	(V _{DD} – 1.5V)	V	Figure 3-1		
V _{RST}	RESET Threshold	4.25	_	4.50	V	V _{DD} Falling (Note 2, Figure 3-3)		
Capacitance	e Electrical Characteristics: T_A	= 25°C unless	otherwis	e noted.				
Symbol	Parameter	Min	Тур	Max	Units	Test Conditions		
C _{IN}	Input Capacitance	—	_	5	pF			
C _{OUT}	Output Capacitance	—	_	7	pF			
	al Characteristics: T _A = -40°C to	o +85°C, V _{DD} =	= 5V ±10	%, unless other	wise note	d.		
Symbol	Parameter	Min	Тур	Max	Units	Test Conditions		
t _{RST}	RESET Active Time	500	700	900	msec	Figure 3-2		
t _{ST}	RS Strobe Pulse Width	500	_	_	nsec	Figure 3-1		
t _{TD}	Watchdog Timeout Period	500	700	900	msec	Figure 3-1		
t _{RPD}	V _{DD} Detect to RS LOW	_	_		nsec	Figure 3-3		

Note 1: No output load.

2: All voltages referenced to ground.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin No. (SOT-223, TO-92)	Symbol	Description
1	GND	Ground.
2	V _{DD}	The +5V power supply input.
3	RS	 RESET/STROBE (Bidirectional). The open drain goes active if: 1. V_{DD} falls below 4.5V nominal. 2. If pulled low by an external electronic signal or switch closure. 3. If the watchdog is not strobed within the minimum watchdog timeout period. 4. During power-up and power-down. In the input mode, RS connects to a voltage level shift network (typically a resistor divider to V_{DD}.) The watchdog timer is reset when processor causes a voltage level ≤ V_{STL} to be applied to RS.
4	V _{DD}	The +5V power supply input (SOT-223 only).

3.0 DETAILED DESCRIPTION

The TC32M provides three important functions to safeguard stable processor operation: precision processor monitor, watchdog sanity timer and external override reset control.

3.1 Processor Monitor

The $\overline{\text{RS}}$ pin is immediately driven low any time V_{DD} is below the nominal threshold voltage. As a result, this pin is LOW when power is initially applied, holding the processor in its reset state. $\overline{\text{RS}}$ remains low for a minimum of 500msec after V_{DD} is within tolerance to allow the power supply and processor to stabilize.

3.2 Watchdog Timer

The processor drives the $\overline{\text{RS}}$ pin with an input/output (I/O) line in series with an resistor voltage divider to V_{DD} . Pulling the bottom resistor of this divider low results in an internal voltage change (*strobe*) sufficient to reset the watchdog timer, but above the V_{IL} input threshold of the processor RESET pin. The processor must continuously apply strobes in this manner within a set period to verify proper software execution. A momentary reset (500msec minimum) is generated by the TC32M if a hardware or software failure keeps RS from being strobed within the watchdog timeout period. This action typically initiates the processor's power-up routine. If the interruption persists, new reset pulses are generated each timeout period until RS is strobed. This timeout period is typically 700msec.





The software routine that drives the RS strobe must be in a section of the program that executes frequently enough so the time between toggles is less than one watchdog timeout period. The strobe signal can be derived from microprocessor address, data and/or control signals. Typical circuit examples are shown in Figure 3-4.

3.3 Resistor Value Selection

The values of R1 and R2 must be chosen to ensure a valid low strobe level (V_{STL}) on RS when the processor I/O line is low. The use of $10k\Omega$, $\pm 5\%$ tolerance resistors are recommended. These values result in a nominal strobe level of 2.5 on RS (min/max of 2.13V/ 3.08V, assuming $V_{DD} = 5.0V \pm 10\%$). Other resistor values can be used, so long as the additive tolerances of the power supply and resistor values result in a strobe that falls within V_{STH} and V_{STL} under all additive tolerance conditions.

3.4 External Override Reset Control

A built-in debounce circuit allows a push-button switch (PB) or other electronic signal to be wire-ORed to this pin as an external RESET override control. The external RESET is required to be an active low signal. Internally, this input is timed to provide a minimum RESET pulse width of 500msec. Reference Figure 3-2.

RS PULLED LOW BY

FIGURE 3-2:



FIGURE 3-3: POWER UP/DOWN RESET TIMING



3.5 Supply Monitor Noise Sensitivity

The TC32M is optimized for fast response to negativegoing changes in V_{DD}. Systems with an inordinate amount of electrical noise on V_{DD} (such as systems using relays), may require a 0.01μ F bypass capacitor to reduce detection sensitivity. This capacitor should be installed as close to the TC32M as possible to keep the capacitor lead length short.

TC32M HARDWARE CONNECTIONS (R1, R2 CHOSEN TO MEET V_{STH} , V_{STL}) FIGURE 3-4: 5V 5V C Q Microprocessor Microcontroller R1, 10kΩ R1, 10kΩ Decoder R2, 10kΩ R2,10kΩ RS PO.1 Address TC32M + RS RESET RESET TC32M -0 RESET RESET Microcontroller Example Microprocessor Example

4.0 PACKAGING INFORMATION

4.1 Package Marking Information

Package marking data not available at this time.

4.2 Taping Form





4.3 Package Dimensions





PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART CODE	TC32M	<u>X</u>	<u>xx</u>
Temperature: C: Commercial (0°C to E: Extended (-40°C to -			
Package Type: ZB: 3-Pin TO-92 DB: 3-Pin SOT223 DB713: 3-Pin Tape & Re	eel SOT223		

Sales and Support

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- 1. Your local Microchip sales office
- 2. 3. The Microchip Corporate Literature Center U.S. FAX: (480) 792-7277
- The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

New Customer Notification System

Register on our web site (www.microchip.com/cn) to receive the most current information on our products.

TC32M

NOTES:

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights.

Trademarks

The Microchip name and logo, the Microchip logo, FilterLab, KEELOQ, microID, MPLAB, PIC, PICmicro, PICMASTER, PICSTART, PRO MATE, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

dsPIC, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, microPort, Migratable Memory, MPASM, MPLIB, MPLINK, MPSIM, MXDEV, MXLAB, PICC, PICDEM, PICDEM.net, rfPIC, Select Mode and Total Endurance are trademarks of Microchip Technology Incorporated in the U.S.A.

Serialized Quick Turn Programming (SQTP) is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2002, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.





Microchip received QS-9000 quality system certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona in July 1999 and Mountain View, California in March 2002. The Company's quality system processes and procedures are QS-9000 compliant for its PICmicro® 8-bit MCUs, KEELoo® code hopping devices, Serial EEPROMs, microperipherals, non-volatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001 certified.



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: 480-792-7627 Web Address: http://www.microchip.com

Rocky Mountain

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7966 Fax: 480-792-7456

Atlanta

500 Sugar Mill Road, Suite 200B Atlanta, GA 30350 Tel: 770-640-0034 Fax: 770-640-0307

Boston

2 Lan Drive, Suite 120 Westford, MA 01886 Tel: 978-692-3848 Fax: 978-692-3821

Chicago

333 Pierce Road, Suite 180 Itasca, IL 60143 Tel: 630-285-0071 Fax: 630-285-0075

Dallas

4570 Westgrove Drive, Suite 160 Addison, TX 75001 Tel: 972-818-7423 Fax: 972-818-2924

Detroit Tri-Atria Office Building 32255 Northwestern Highway, Suite 190

32255 Northwestern Highway, Suite 190 Farmington Hills, MI 48334 Tel: 248-538-2250 Fax: 248-538-2260 **Kokomo**

2767 S. Albright Road Kokomo, Indiana 46902 Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles

18201 Von Karman, Suite 1090 Irvine, CA 92612 Tel: 949-263-1888 Fax: 949-263-1338

New York

150 Motor Parkway, Suite 202 Hauppauge, NY 11788 Tel: 631-273-5305 Fax: 631-273-5335

San Jose

Microchip Technology Inc. 2107 North First Street, Suite 590 San Jose, CA 95131 Tel: 408-436-7950 Fax: 408-436-7955

Toronto

6285 Northam Drive, Suite 108 Mississauga, Ontario L4V 1X5, Canada Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Australia

Microchip Technology Australia Pty Ltd Suite 22, 41 Rawson Street Epping 2121, NSW Australia

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755 China - Beijing

Microchip Technology Consulting (Shanghai) Co., Ltd., Beijing Liaison Office Unit 915 Bei Hai Wan Tai Bldg. No. 6 Chaoyangmen Beidajie Beijing, 100027, No. China Tel: 86-10-85282100 Fax: 86-10-85282104

China - Chengdu

Microchip Technology Consulting (Shanghai) Co., Ltd., Chengdu Liaison Office Rm. 2401, 24th Floor, Ming Xing Financial Tower No. 88 TIDU Street Chengdu 610016, China Tel: 86-28-86766200 Fax: 86-28-86766599

China - Fuzhou

Microchip Technology Consulting (Shanghai) Co., Ltd., Fuzhou Liaison Office Unit 28F, World Trade Plaza No. 71 Wusi Road Fuzhou 350001, China Tel: 86-591-7503506 Fax: 86-591-7503521 **China - Shanghai**

Microchip Technology Consulting (Shanghai) Co., Ltd. Room 701, Bldg. B Far East International Plaza No. 317 Xian Xia Road Shanghai, 200051 Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

China - Shenzhen

Microchip Technology Consulting (Shanghai) Co., Ltd., Shenzhen Liaison Office Rm. 1315, 13/F, Shenzhen Kerry Centre, Renminnan Lu Shenzhen 518001, China Tel: 86-755-2350361 Fax: 86-755-2366086

China - Hong Kong SAR

Microchip Technology Hongkong Ltd. Unit 901-6, Tower 2, Metroplaza 223 Hing Fong Road Kwai Fong, N.T., Hong Kong Tel: 852-2401-1200 Fax: 852-2401-3431

India

Microchip Technology Inc. India Liaison Office Divyasree Chambers 1 Floor, Wing A (A3/A4) No. 11, O'Shaugnessey Road Bangalore, 560 025, India Tel: 91-80-2290061 Fax: 91-80-2290062

Japan

Microchip Technology Japan K.K. Benex S-1 6F 3-18-20, Shinyokohama Kohoku-Ku, Yokohama-shi Kanagawa, 222-0033, Japan Tel: 81-45-471-6166 Fax: 81-45-471-6122 Korea Microchip Technology Korea 168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku Seoul, Korea 135-882 Tel: 82-2-554-7200 Fax: 82-2-558-5934 Singapore Microchip Technology Singapore Pte Ltd. 200 Middle Road #07-02 Prime Centre Singapore, 188980 Tel: 65-6334-8870 Fax: 65-6334-8850 Taiwan Microchip Technology Taiwan 11F-3, No. 207 Tung Hua North Road Taipei, 105, Taiwan

Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

Denmark

Microchip Technology Nordic ApS Regus Business Centre Lautrup hoj 1-3 Ballerup DK-2750 Denmark Tel: 45 4420 9895 Fax: 45 4420 9910

France

Microchip Technology SARL Parc d'Activite du Moulin de Massy 43 Rue du Saule Trapu Batiment A - ler Etage 91300 Massy, France Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79 **Germany** Microchip Technology GmbH Gustav-Heinemann Ring 125

Gustav-Heinemann Ring 125 D-81739 Munich, Germany Tel: 49-89-627-144 0 Fax: 49-89-627-144-44 Italy

Microchip Technology SRL Centro Direzionale Colleoni Palazzo Taurus 1 V. Le Colleoni 1 20041 Agrate Brianza Milan, Italy Tel: 39-039-65791-1 Fax: 39-039-6899883

United Kingdom

Microchip Ltd. 505 Eskdale Road Winnersh Triangle Wokingham Berkshire, England RG41 5TU Tel: 44 118 921 5869 Fax: 44-118 921-5820

05/01/02